BRIGHT VIEW ELECTRONICS CO.,LTD

# **ULTRA BRIGHTNESS LED LAMP**

**PACKAGE CONFIGURATION** 

-3.2

3.0

1.0Max.

25.4Min.

- 2.54

9.8±0.5

1.3

CATHODE

1.0Min.

ŧ

32

3,5

1.0

CATHODE

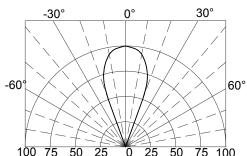
0.5-

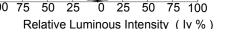
BVU-3R16BA4

#### DESCRIPTION

Dice Material : GaN Blue Light Color : Blue Color Lens Color : Water Transparent Stand-Off P/N : BVU-3R16BA4 R

#### **RADIATION PATTERN**





# ABSOLUTE MAXIMUM RATINGS AT Ta = 25 °C

Tolerance ± 0.25 mm

- 2.54

1.0

25.4Min.

ADOOL					a = 2						
_		I	PARAME	ſER				M	AX.		UNIT
Power Dissipation (PD)						120				mW	
Continuo	us Forward	Current	(IF)					3	30		mA
Peak For	ward Curre	ent (1/10	Duty Cyc	le , 0.1m	s Pulse	Width ) (IFP)		1	60		mA
Reverse	Voltage (V	R)							5		V
Derating	Linear Fro	m 25 ℃						0	.4		mA/ºC
Operating	J Temperat	ure Rang	e (Topr)					−30 °	C to + 5	<b>80</b> ℃	
Storage	Temperatur	e Range	(Tstg)					$-40 \degree C$ to $+ 100 \degree C$ ds. (Tsld)			
Lead Sol	der Tempe	erature 1.6	6 mm Bel	ow Packa	age 260	$^\circ\!\mathrm{C}$ for 5 seco	nds (Tsl	d)			
ELECTR	ICAL / OF	TICAL (	CHARAC	TERIST	CS AT	Ta = 25 ℃					
SYMBOL	F	PARAMET	ER	TEST (	COND.	MIN.	T	YP.	N	IAX.	UNIT
VF	Forward	Voltage		l f = 2	0 mA		3	.2	2	4.0	V
l r	Reverse	Current		V r =	= 5V					10	$\mu A$
λp	Peak Em	ission Wa	velength	l f = 2	0 mA		4	65			n m
λd	Dominan	t Waveler	ngth	l f = 2	0 mA		4	470			n m
2 <i>θ</i> 1/2	Viewing	Angle		l f = 2	0 mA		4	40		Deg	
Ιv	Luminous	s Intensity	/	l f = 2	0 mA	1300	1680			mcd	
<b>BIN GR</b>	ADE LIM	ITS (IF=	20 mA)				BIN C	GRADE	E LIMIT	S (IF=2	0 mA)
LUMING	DUS INTE	ENSITY /	mcd				DOM	INANT	WAVE	ELENG	ΓH / nm
Bin	K	L	М	Ν			Bin	BM	BN	BO	-
Min.	1300	1680	2180	2800			Min.	460	465	470	-
Max.	1680	2180	2800	3600			Max.	465	470	475	-
				Telere	$naa \pm 11$	E0/mod					

Tolerance ± 15%mcd

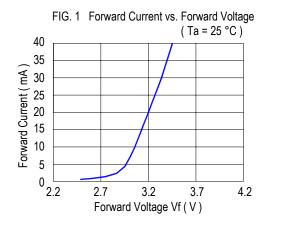
\*Bright View reserves the rights to alter specifications and remove availability of products at any time without notice.

\*Dominant Wavelength,  $\lambda\,\text{d}$  is according to CIE Chromaticity Diagram base on color of lamps.

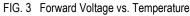
\* $\theta$  1/2 is the off-axis angle where the luminous intensity is one half the on-axis intensity.

\*These products are sensitive to static electricity. Caution must be taken strictly to avoid static electricity.





## TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES



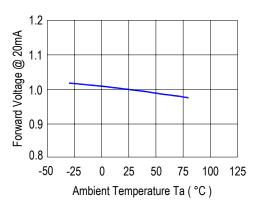
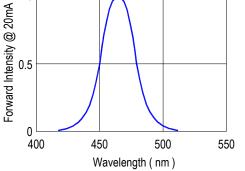


FIG. 5 Relative Intensity vs. Wavelength (  $\lambda p$  ) ( Ta = 25 °C ) 1.0



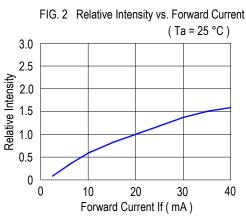
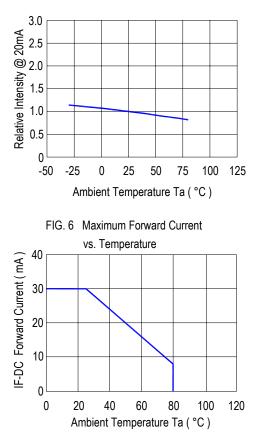


FIG. 4 Relative Intensity vs. Temperature





### CAUTION FOR CLASS 1 ESD ( MACHINE MODE )

Gallium Nitride (GaN) based light emitting diodes (LEDs) are extremely sensitive to electrostatic discharge (ESD). Users are strongly recommended to take necessary meter to test the static and avoid ESD when handing these products.

Bright View's BA, GN, WI series products are GaN based materials and are classified as "Class 1",( ESD endurance 50V or lower ), any manufacturing site or workstation where GaN devices are handled should be rated and controlled at 50V or below.

Proper grounding of products or machines (via  $1M\Omega$ ), using static dissipative mats, static dissipative containers, static dissipative working uniferms and shoes are considered to be effective against ESD.

An ionizer is recommended in the facility or environment where ESD may be generated easily, and soldering iron with a grounded tip is also recommended.

To install a protection device in the LED circuit to ensure the surge current and voltage not exceeding the max rating during on/off swithing.

When inspecting the final products in which LEDs are assembled, it is recommended to check whether the assembled LEDs are damaged by ESD or not. It is simple to find damaged LEDs by light-on or a VF test at lower current (below 1mA is recommended).

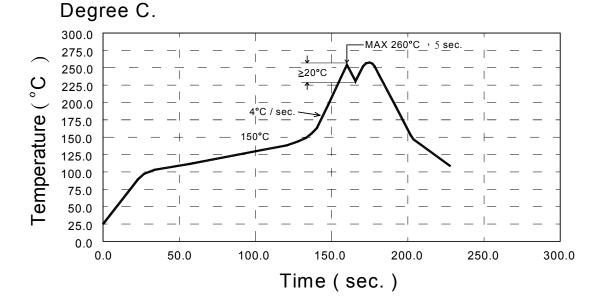
ESD damaged LEDs will show some unusual characteristics such as the remarkable increasing of leak current, the forward voltage become lower, or the LEDs do not light on at the low current.



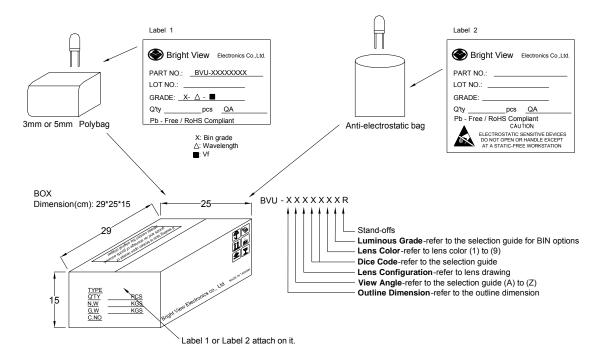
## Apply to LAMP(DIP) series.

Description:

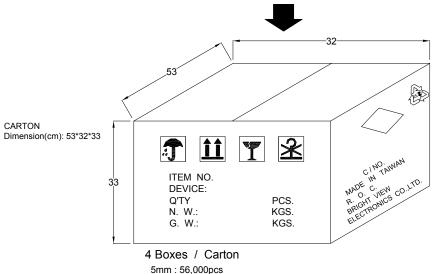
- (1) Manual soldering (Solder Iron)
  - (1.1) Temperature at tip of the iron: 300°C Max.
  - (1.2) It's banned to load any stress on the resin during soldering.
  - (1.3) Soldering time: 3 sec. Max.(one time only)
  - (1.4) Leave 3mm of minimum distance from the base of epoxy.
- (2) Dip Soldering(Wave soldering-Solder Bath)
  - (2.1) Leave 3mm of minimum distance from the base of the epoxy. Soldering beyond the base of the tie bar(stand off) is recommended.
  - (2.2) When soldering, do not put stress on the LEDs during heating.
  - (2.3) Cutting the leadframes at high temperatures may cause LED failure.
  - (2.4) Never take next process until the component is cooled down to room temperature after reflow.
  - (2.5) After soldering, do not warp the circuit board.
  - (2.6) The recommended dip soldering profile is the following:







Device	Q'ty / Polybag (pcs)	Polybag / Box A	Fig.
5mm(T-1 3/4)	1000pcs	14 bags	Label 1
3mm(T-1)	1000pcs	20 bags	Label 1
Blue / Green / White	500pcs	18 bags	Label 2



Blue / Green / White : 36,000pcs